Towards high-resolution X-ray Spectral imaging

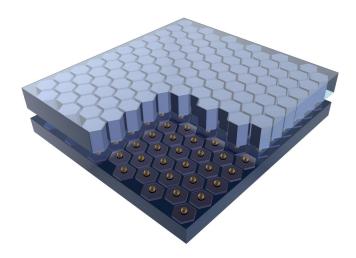
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High resolution Imager for X-rays



We plan to develop a new class of **large area**, **hybrid pixel detectors** with fast, event-driven analog read-out and single-photon sensitivity for high resolution **X-ray spectral imaging of celestial sources** through satellite observations and for **X-ray diffraction (XRD)**, fluorescence and microtomography of industrial, chemical and biological samples.

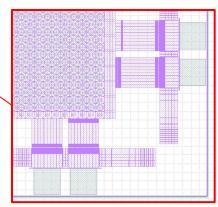
Single Photon Position, Energy and Time in one shot!

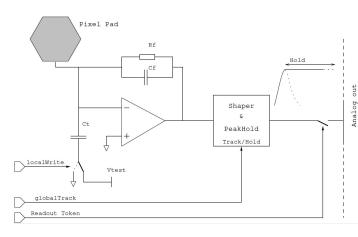
- -) ~10 μ m spatial resolution
- -) ~300eV energy resolution (FWHM at 8 keV)
- -) 50u pixels with high speed and low noise (≤ 30e- ENC) Analog readout
- -) Active Area (>2cm^2)

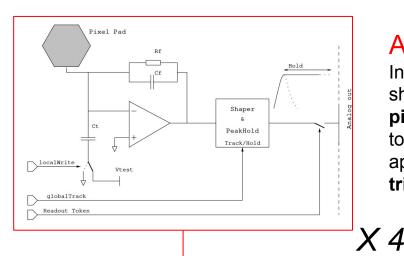
Readout ASIC

XPOL-III is a readout full custom ASIC developed as part of a GEM based GAS detector for soft X-ray (2-8keV) polarimetry.

- Analog Readout
- CMOS TSMC 0.18u
- 304X352 (107.008) pixels (15.2mm X 15.24mm)
- 50u pitch (triangular pattern)
- Low noise (~30e- ENC)
- self triggering
- adequate rate capability (~10kHz)



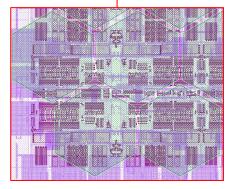




Trigger

Α

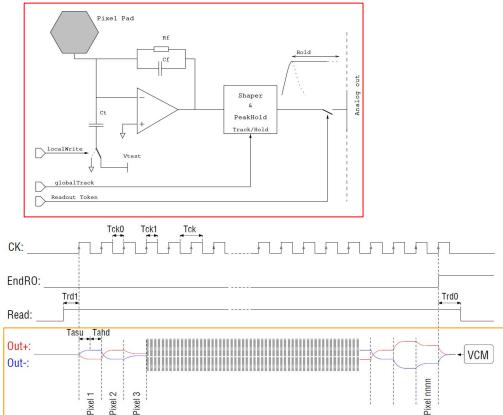
In addition to the main signal conditioning chain (CSA + 1us shaper), pixels have a faster shaper(O(300ns)). Every 4 pixels(mini-cluster), such faster outputs are summed together and compared versus a global threshold (externally applied) generating a local digital trigger (mini-cluster trigger).



B

Mini-cluster triggers are internally or-ed to generate a global (self)trigger signal (externally routed to the DAQ also) which activates pixels peak detectors.

A dedicated logic identifies the **vertices** of a rectangular area (ROI) enclosing the triggering mini-clusters (ROT) + a programmable margin and selects them for the readout

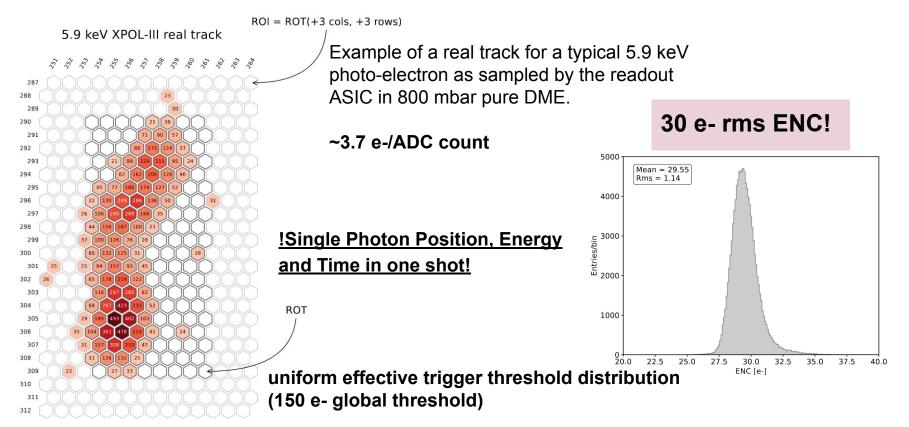


Readout

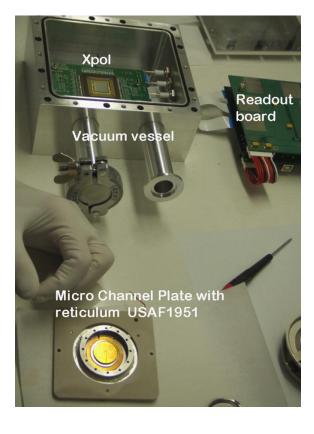
Upon the trigger reception the external DAQ electronics, starts mastering the readout sequence. Which, after the ROI Xmin, Xmax, Ymin, Xmax coordinates have been acquired, consists of a sequential readout of the pixels belonging to the ROI by means of a scan of the pixels peak detectors analog outputs which are serially connected to a differential output buffer at the chip periphery and Analog to Digital (A/D) converted by the DAQ's 14-bits pipeline ADC.

> Charge detected by each pixel within the ROI is converted to a differential output voltages to be acquired by the external DAQ electronics

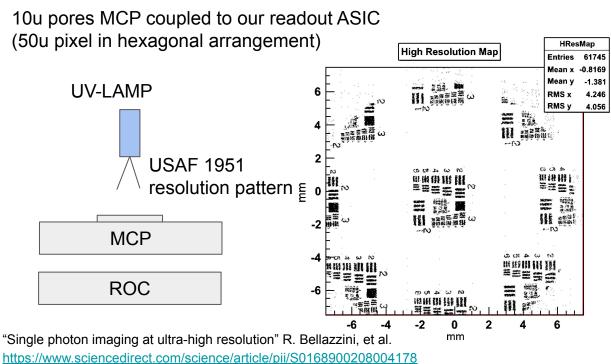
First tests



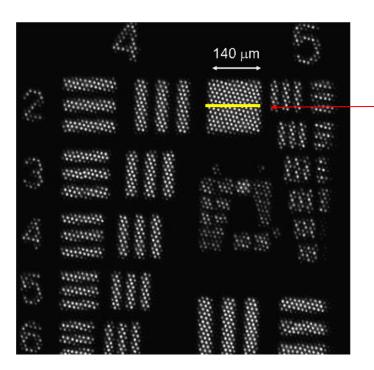
Imaging Capabilities

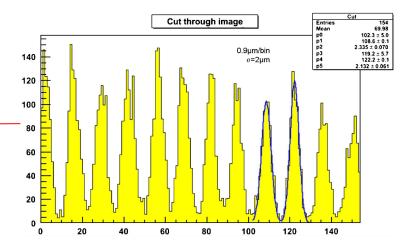


Sub-pixel resolution Imaging Experiment



Imaging Capabilities



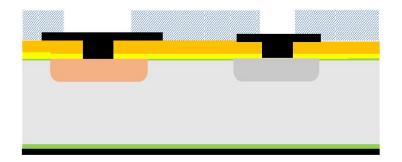


MCP pores 10u aperture / 12u pitch are clearly resolved

Charge converter device is limiting the resolution, readout intrinsic resolution is much lower thanks to the centroid reconstruction

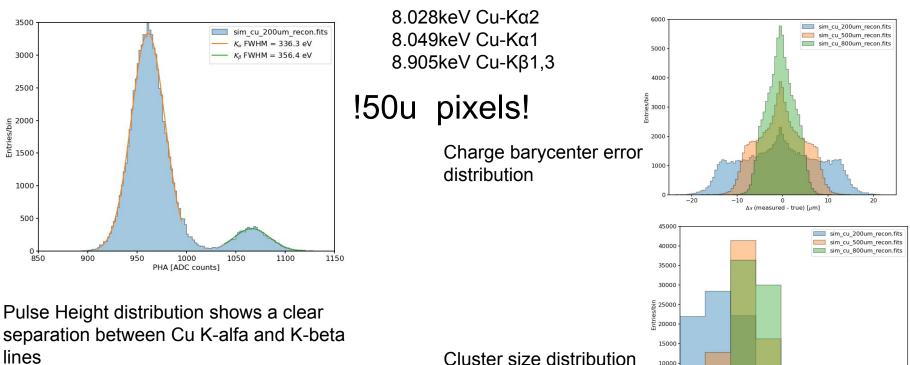
Next Steps

Sensor design and development



XPOL-III Si Sensor 300u thick 50um pitch

MC Simulations in Si detector



5000

4 5 6 7 Number of pixels over threshold

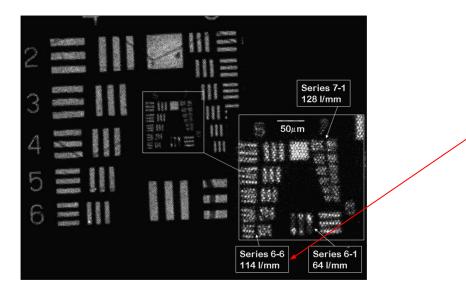
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Conclusions

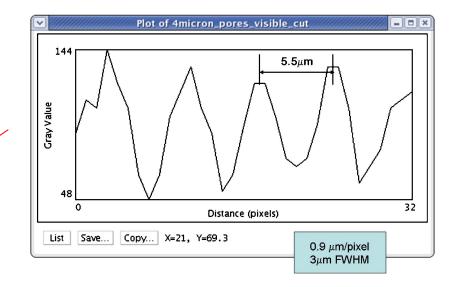
A new approach, based on single photon detection and full analog readout for hybrid pixel sensors is paving the way towards high spectral, positional and timing resolution X-ray imaging.

Preliminary experiments and simulations have been conducted and demonstrate its feasibility.

Imaging Capabilities



MCP 4u aperture pores



114 lp/mm Series 6-6 image profile

spatial resolution still limited by the MCP